



# New vision of I-V characteristics in irradiated Si sensors with heavily damaged region

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38 RD50 Collaboration Workshop on-line, June 21-23, 2021 The study extends our presentation at 37 RD50 workshop (V. Eremin, et al....)

# Radiation field expected for Si detectors in HL-LHC

ATLAS inner tracker at HL-LHC:  $F_{max} = 2 \times 10^{16} n_{eq}/cm^2$ 

Radiation-induced defects: point and clusters

In degradation of Si detectors placed close to the interaction points (pixels, short strips) contribution of defect clusters will dominate!

# Goal

Perform analysis of I-V characteristics aimed at disclosing the mechanisms contributing to the bulk current of heavily damaged Si sensors

### For this:

- Enforce formation of clusters by irradiating Si sensors with ions creating local heavily damaged region at a known position (medium energies, ion range less than sensor thickness);
- Build the algorithm of I-V characteristic analysis,
- Derive the profile of the current and current generation rate,
- Give insight into the influence of heavily damaged region on the bulk current in irradiated Si sensors.

# Experimental

### Samples

- Pad p<sup>+</sup>-n-n<sup>+</sup>
- n-type CZ Si,  $\rho \sim 60 \ \Omega cm$ , N<sub>0</sub> = 7.1×10<sup>13</sup> cm<sup>-3</sup>, d = 300  $\mu m$ , S = 0.23 cm<sup>-2</sup>

#### Irradiation:

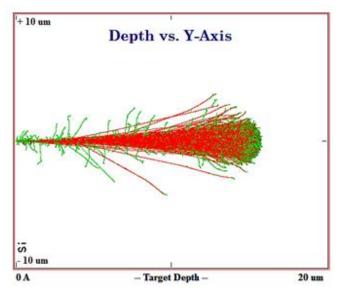
- loffe Institute cyclotron
- 53.4 MeV <sup>40</sup>Ar ions, RT
- Ion range 15 μm
- 3 fluences: F1=1×10<sup>9</sup>, F2=2×10<sup>9</sup>, F3=4×10<sup>9</sup> ion/cm<sup>2</sup>
- dose rate (flux) 2×10<sup>7</sup> cm<sup>-2</sup>s<sup>-1</sup>

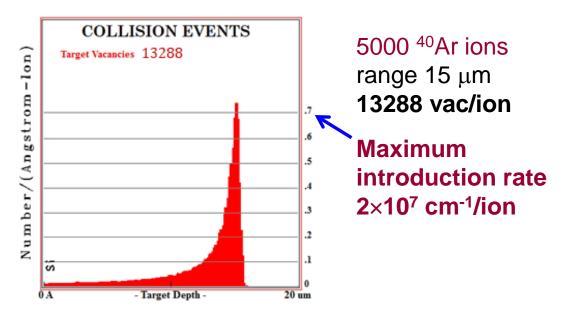
#### **Measurements:**

- I-V characteristics
- C-V characteristics

Simulation: TRIM

# Simulations of collision events produced by 53.4 MeV <sup>40</sup>Ar ions (TRIM)





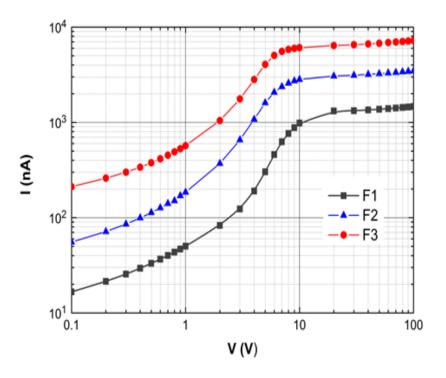
**Collision cascades** red – moving ions,

green – recoils

Profile of primary defect (vacancies) concentration  $N_v(x)$  along the track

- N<sub>v</sub>(x) has a shape with a Bragg peak at the track end
- $N_v$  maximum at x = 15.2  $\mu$ m
- Within the BPR (x = 13-15 μm), N<sub>v</sub>(x) is up to 100 times higher than at the beginning of the track

## I-V characteristics



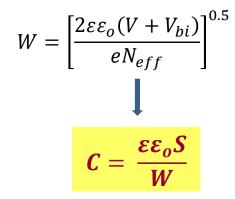
### Preliminary assignment: three regions:

- ✓ moderate rate of current rise ~0-(1-2) V, Low Damaged Region (LDR)
- ✓ higher rate, Bragg Peak Region (BPR)
- ✓ slow rise, Non-Damaged Region (NDR), insignificant current increase (ohmic leakage?)

# Algorithm of I-V characteristic analysis

- Determinating the voltage dependence of SCR depth W-V using C-V characteristics,
- 2. Translating I-V characteristics to I-W (I-x) characteristics,
- Profiling the derivative of the current density J →
  current density gradient dJ/dx over the depth of the damaged region,
- 4. Calculating the diffusion current new point in the study.

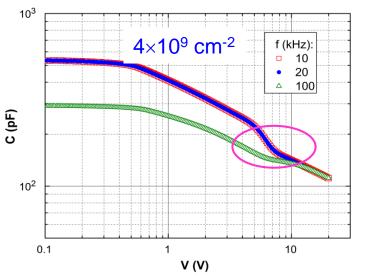
# 1. Determinating SCR depth W from C-V characteristics

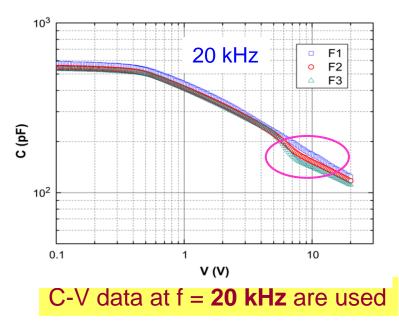


N<sub>eff</sub> is nonuniform and unknown

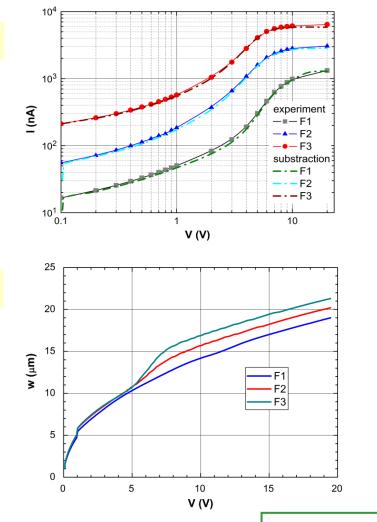
In Si samples irradiated with neutrons capacitance depends on frequency f

*Z. Li and H.W. Kraner, IEEE Trans. Nucl.Sci.* 38 (1991) 244 *E. Borchi, et al., Sol. State Electron.* 42 (1998) 2093





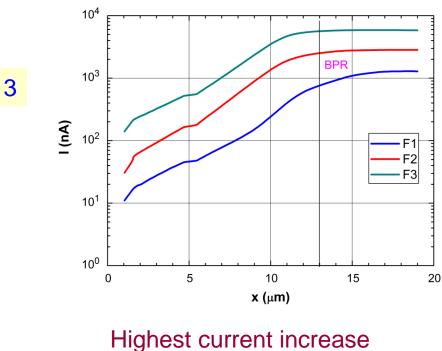
### 2. Translation of I-V characteristics to I-W characteristics



1

2

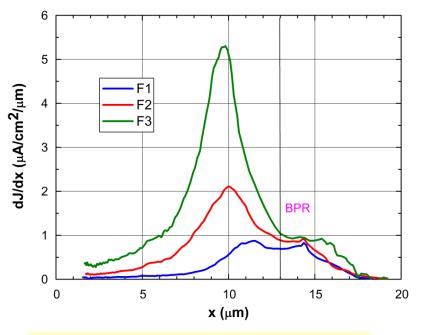
Done in 3 steps: 1) subtraction of leakage from I-V, 2)  $V \rightarrow W$ , 3) I-V  $\rightarrow$  I-W; W is x



is not in the BPR!

# 3. Profiles of the current density gradient

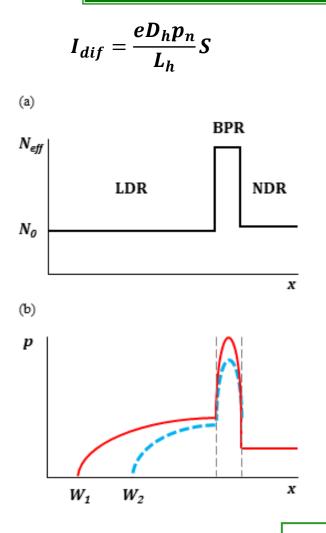
### Current density gradient (current generation rate) dJ/dx



- <sup>40</sup>Ar, 53.4 MeV:
  α = 6.7×10<sup>-12</sup> A/cm
- 23 GeV protons and 1 MeV neutrons: α = 4×10<sup>-17</sup> A/cm

- Dependences are nonmonotonic
- dJ/dx increases with F over the most part of LDR
- dJ/dx maxima are not in the BPR (shifted towards p<sup>+</sup>-n junction)!
- dJ/dx depends on F:
  - F1: only slightly changes within 11-14  $\mu m$
  - F2 and F3: reduction beyond 10 μm including BPR
- In the BPR (~13-15 μm) dJ/dx is almost insensitive to F and shows a plateau

# 4. Calculating the diffusion current



### Nondepleted BPR:

- diffusion of holes from BPR to LDR due to their gradient p/L<sub>h</sub>, p<sub>LDR</sub> < p<sub>BPR</sub>
- nonuniform hole profile according to the boundary condition: p<sub>n</sub> = 0 at x = W,
- within BPR hole concentration depends on F, i.e., on defect concentration,
- $L_{LDR} > L_{BPR}$ , therefore
- holes having reached LDR diffuse and can arrive to W contributing to the diode current.

**Depleted BPR:** 

Exhaustion of hole source

# Estimation of diffusion current

#### **Assumption**:

Compensation of  $N_0$  (7.1×10<sup>13</sup> cm<sup>-3</sup>) in BPR occurs due to the dominant introduction of acceptor-type radiation defects:

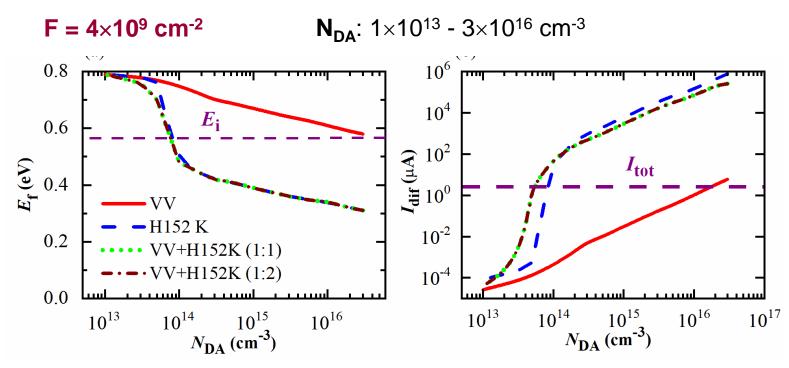
- point defects  $VV^{-}$ ,  $E_{c} 0.42 \text{ eV}$ ,
- cluster-related defects H152 K acting as hole traps in the lower part of Si bandgap,  $\Delta H_{152K} = E_v + 0.42eV$  (I. Pintilie et al., NIM A 611 (2009) 52)

$$I_{dif} = \frac{eD_h p_n}{L_h} S \qquad n = N_{DA} exp\left(-\frac{E-E_F}{kT}\right) - \text{occupancy of DLs}$$
$$L_h = \sqrt{D_h \tau_{rec\_h}} \qquad p - n + N_o - N_{DA} = 0 - \text{neutrality condition}$$

$$\tau_{rec\_h} = \left( v_{th\_h} \sigma_h N_{DA} \right)^{-1}$$

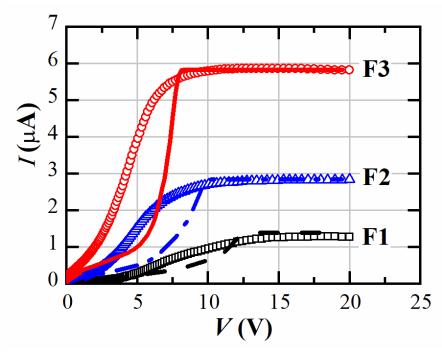
 $N_{DA}$  – concentration in BPR, variable

## Contribution of diffusion current



VV<sup>-</sup>: gradual changes of E<sub>f</sub> and I<sub>dif</sub>; compensation at N<sub>DA</sub> ≥  $3 \times 10^{16}$ H152 K or VV- + H152 K: compensation and sharp I<sub>dif</sub> increase at N<sub>DA</sub> ≥  $(3-5 \times 10^{13}$  NB: area of clusters may be **less** than S, and I<sub>dif</sub> rise may be lower Conclusion: both defects can contribute to the diffusion current

# Comparison of I-V characteristics



Simulation of generation current: N<sub>v</sub> scaling factor = 0.019

→ only few % of vacancies and interstitials escape annihilation and contribute to defect formation *e.g. E. Monakhov, et al., Phys. Rev. B* **65** (2002) 245201

Symbols: experimental Dash: simulation of generation current using TRIM data

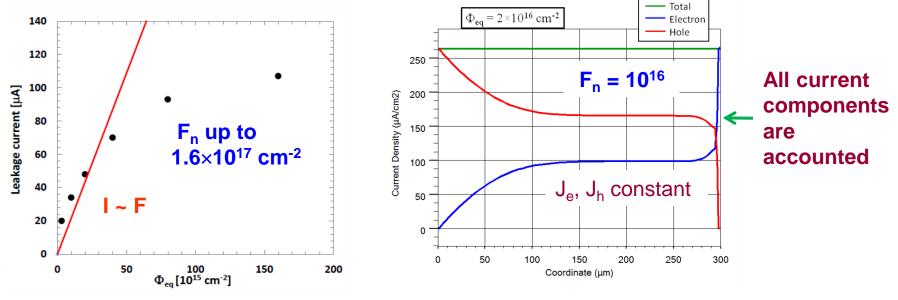
Agreement only within few initial  $\mu m$ 

# Assignment of sharp current rise in I-V characteristics to the bulk generation current in BPR is incorrect!

# Additional mechanism affecting I-V and dJ/dx shapes

### Reduction of dJ/dx and plateau in dJ/dx(x):

- Exhaustion of hole flow from BPR,
- Additional mechanism: formation of local compensated regions in BPR acting as neutral conductive base without a contribution to the current



G. Kramberger, et al., 2013 JINST 8 P08004

V. Eremin, et al., 2017 JINST 12 P0900

**Neutrons:**  $F \ge 2 \times 10^{16} \text{ cm}^{-2} \rightarrow \text{ conversion from I} \sim F \text{ to I} \sim \sqrt{F}$ 

### Summary

- A new finding in the study of Si sensors irradiated with medium energy Ar ions is that dJ/dx profiles are nonmonotonic. Contrary to expected, their maxima are not located in the BPR.
- Nondepleted BPR acts as a source of diffusion current of holes generated in the BPR and flowing towards the SCR border, thus contributing to the total current.
- Suppression of dJ/dx inside the depleted Bragg peak region is explained by two factors:
- 1) exhaustion of the hole diffusion from the BPR,
- 2) formation of local compensated high resistivity regions within the BPR acting as neutral conductive base without contribution to the sensor current.
- Effect of current rise suppression with fluence is common for Si sensors with heavily damaged regions enriched with clusters, such as track ends of shortrange ions, or uniformly distributed regions produced by 1 MeV neutrons at F > 10<sup>16</sup> n<sub>eq</sub>/cm<sup>2</sup> and ions with GeV energy.

# Thank you for attention!